### **3M<sup>™</sup> CMP Pad Conditioner Coatings**

# Redefining metal contamination protection

Micron-thick, clear coatings from 3M trap metal ions, preventing them from leaching into the slurry or wafer and helping protect the disk from acidic slurries.

### Up to 99% reduction in metal contamination during long CMP processes<sup>1</sup>

| Metal     | Without<br>Coating | With Coating<br>(initial) | With Coating<br>(after 20-hour<br>soaking) |  |
|-----------|--------------------|---------------------------|--|--|
| Iron      | 1410               | 0.23                      | 0  |  |
| Manganese | 276                | 0                         | 0  |  |
| Nickel    | 15900              | 0                         | 0  |  |
| Chromium  | 262                | 0                         | 0  |  |

<sup>1</sup>3M test results for the U coating in a pH 4.5-5.5 slurry

## Understanding metal leaching in CMP

Semiconductor CMP slurries are abrasive. That's their job. But that abrasiveness means that they often leach metals like nickel, manganese or iron out of the pad conditioner. This metal contamination has been shown to reduce yield in both advanced and mature node processes. Harsh slurries like permanganates can even corrode the disk surface itself.

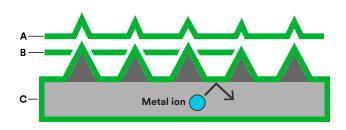


#### Metal leaching effects

- Reduced yield
- Substrate corrosion or diamond loss
- Metal residue on IC surface



### **Performance plus** process control, minus metal contamination

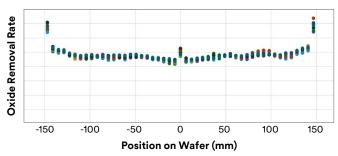


#### Surface, selective and full-disk application patterns enable tailored coating solutions for different process needs

- A. Surface coating: Coat the full contact surface of the disk.
- B. Selective area coating: Coat specific parts of the disk for targeted protection.
- **C.** Full disk coating: For extra-sensitive processes, the whole disk can be coated to comprehensively minimize metal contamination.

**Oxide Removal Rate** -100 100 -150 -50 0 50 150 Position on Wafer (mm)

#### Coated Conditioner (250 wafers run)



#### No negative impact on CMP performance, including removal rate and profile

View 3M test results

| Coating   | Color | Metal Leaching<br>Reduction* | Coating Options                       | Туре                       | Effective Slurry<br>pH range | Compatibility           |
|-----------|-------|------------------------------|---------------------------------------|----------------------------|------------------------------|-------------------------|
| K Coating | Clear | Up to 75%                    | Surface                               | Hydrophobic<br>Hydrophilic | pH 2-12                      | All 3M pad conditioners |
| U Coating | Clear | Up to 99%                    | Surface, Selective area,<br>Full disk | Hydrophobic                | pH 2-12                      | All 3M pad conditioners |

\* Per 3M test data

Safety Data Sheet: Consult Safety Data Sheet before use.

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**Uncoated Conditioner (250 wafers run)**